					Product Change Notification			
-					Inter	nal Registration Date		26/11/2021
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			т	E Co	nnectivity	,		
	PCN number	2021069				PCN Date		01/02/2022
E	CR project number	2021009				FCN Date		DD.MM.YYYY
TE wo	uld like to infor	m you of the	e follov	wing ch	ange(s) to the	listed TE Connec	ctivity	/ Product. In cas
	of any	/ further que	stions	about	his change(s),	please contact y	our 7	ΓE
Conne	ectivity Sales Er	ngineer. Affe	cted p		-	pecification num	bers	are listed on the
				attach	ed sheet(s).			
General F	Product Description							
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